

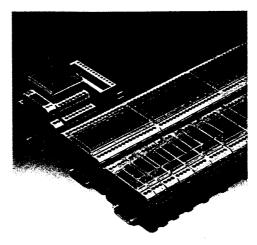
ectronic Component ousings and PC Board uses for Custom Circuits

Nith the trend to distribution and appliion of new technologies, more and more npact rail mountable housings with inteted connection systems are required for nponent PC board bases.

The comprehensive Phoenix housing ge comprises three harmonized product oups: The MODUFACE and UEG/UEGM mponent housings and the UM/UMK PC ard bases for custom circuits. The houss which are conceived in accordance h the modular principle accept printed cuit boards from a few square centimes up to complex cards. All housings have common the high stability, the solid workınship and the rail mountable design. The machine mounted components and dered electronic groups are safely inteited in the component housings without ditional screw fitting and provide full ock protection. The housings offer a wide ige of connections from solid screw conctions up to 2.5 mm² and tab connecns through to multi-position electronic ig connectors.

The use of standard component hougs reduces development time and costs, even the smallest batches and indivial equipment can be economically proced. For large series the housings can be shed in a choice of six other colors in dition to the standard green color.

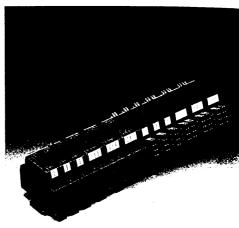
Range Review



Component Housing MODUFACE

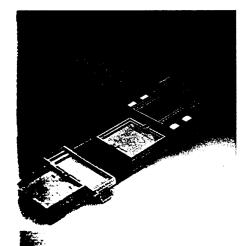
MODUFACE component housings are rail mountable small housings accepting electronic circuits and standard components.

MODUFACE offers a selection of approx. 20 housing variations, which are available with a number of positions and grids from 10 mm to 150 mm. The empty housings are offered with screw, tab or COMBICON connections to meet practical requirements.

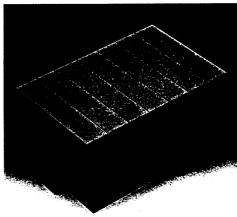


Component Housings UEG

The electronic component housing UEG is particularly suitable to accept made to measure adaption or conversion functions. It is available in 20 and 30 mm construction widths with individual custom fitted double level screw or tab connections. Using the universal foot these empty housings snap on to commercially available DIN EN mounting rails.

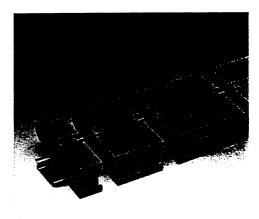


Colowing review shows the various



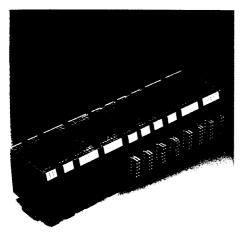
Component Housing UEG-EU

Using this housing for European format cards, even complex electronics are made rail mountable. The empty housing can be matched to all requirements by simply engaging the individual elements. Available as connection system are high position plug connectors as well as the comprehensive range of printed circuit terminal blocks (see catalog page 290).



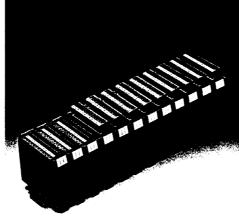
PC Board Bases for Custom Circuits UMK

The universal module UMK permits professional rail mounting of electronics. The PC board bases for custom circuits are comprised of individual elements which can be optionally extended in the mounting rail longitudinal direction in accordance with the printed circuit board size. With its universal foot it can be engaged on commercially available DIN EN mounting rails.



omponent Housings UEGM

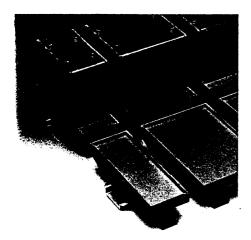
The electronic component housing EGM offers the practical possibility of ting individual interface functions. Due to e various construction widths (22.5, 25 nd 40 mm) with optional screw and/or tab innections it easily meets individual requiments and needs. The housings snap on immercially available DIN EN mounting its



Component Housing UEGM-MSTB

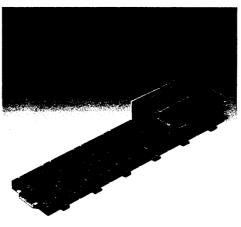
The special feature of these 25 mm wide electronic component housings UEGM-MSTB is the connection of the external conductors through plug-in COMBICON pin strips. All standard COMBICON plug variations from 2 to 12 positions can mate the COMBICON pin strips. The individual connection points can be provided with light diodes. The empty housings possess a universal foot and snap on to commercially available DIN EN mounting rails.

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PC board bases for custom circuits UMK	28-29
Mounting plates UM	30-31
PC board bases for custom circuits MP	32



C Board Bases for Custom Circuits UM

The PC board bases for custom circuits M offer the possibility of economically and Jickly expanding rail mounted electronic rcuits. The printed circuit board size can equivalent optionally expanded in the mounting rail ngitudinal direction by simply fitting the M base elements in rows. The modules e available both with and without end evers. Due to their universal foot, these odules snap on to commercially available IN EN mounting rails.



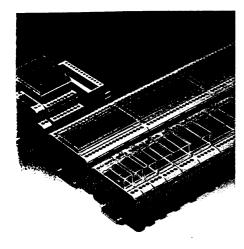
Mounting Plates MP

The mounting plates for rail fitting have been specially designed to accept size 0 switching equipment.

ODUFACE

neral

MODUFACE is the name for a complete mponent housing range for the economiarrangement of industrial electronics cording to switch cabinet referenced reirements. In the housing small interface cuits can be fitted as well as complete ntrol units.



The component holder range can be ided into three delivery groups:
The first delivery form: individual parts are supplied without printed circuit boards for complete custom fitting
The second delivery form: the prefabricated modules offer a standard printed circuit board with solder points for custom soldering of construction elements.
The third delivery form: here various housing variations can be individually combined.

Common features for all MODUFACE oducts:

Uniform and well designed housing system

Optimum and space saving accommodation of the electronics in finely stepped module variants, which can be selected in grids from 10 to 150 mm

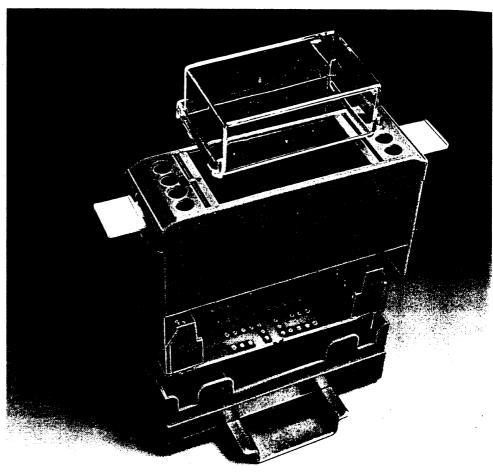
Practical and easily wired conductor connection through solid screw terminals up to 2.5 mm² very fine strand or optional 6.3/2.8x0.8 mm tab connections or COMBICON or electronic plug connectors.

Easy snap fitting on the ___ symmetrical mounting rails in accordance with DN EN 50022

Shock and soil protected accommodation of electronic components Selection between three cover sizes in transparent or non-transparent design.

ogn Principle

The blown-up view indicates the principle the MODUFACE construction: the comment fitted printed circuit board is instead in the housing upper section and becquently reliably engages with the using base (no screws!).



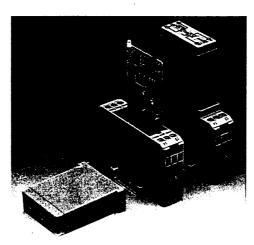
Electronic Component Accommodation

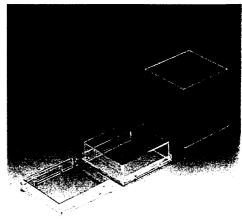
The fine type stages permit optimum adaption of the housings to the required printed circuit board surface for the electronic components and to the required connection positions and: the printed circuit board geometry is rectangular. The layout of each printed circuit board with its dimensions, the connection points and the component side is represented on pages 18–19 in a scale of 1:1. The special feature: all electronic components and printed circuit terminal blocks can be fitted in accordance with production requirements and machine soldered in one operating cycle!

To create construction modules as narrow as possible with comprehensive electronic components, one or several additional PCB's can be mounted perpendicularly on the main PCB, via suitable connection elements. The layout of this additional printed circuit board including dimensions, the points for the connection element and the component side is represented on page 19 in a 1:1 scale.

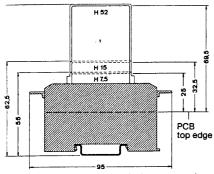
Three Cover Heights

The transparent or non-transparent green hoods available protect the internal electronics from shock and the ingress of dirt. The cover simply snaps on; it can be removed again at any time. The front permits the installation of display or actuation elements and a surface for a circuit print label. Economical quantities justify the production of covers upon request with front break-outs or prints.





Special keying forms ensure that the overs can only be fitted in accordance the circuit, i. e. as per the front print.



A selection can be made between three wer heights, permitting an optimum eight matching to the electronics space quirement. The standard 7.5 and 15 mm gh covers are transparent; upon request conomical quantities allow the covers to effered as non-transparent green. The 52 m high cover is dnly available as non-ansparent green. The tall covers are proted with guide grooves to accept the verially positioned additional printed circuit pards.

onductor Connections

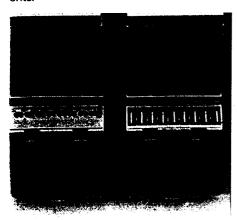
Available designs are:

solid 2.5 mm² screw connections in the form of printed circuit terminal blocks MKDS 3 in 5 mm grid dimensions on both sides (see catalog page 290). Some MODUFACE housings are alternatively available with screw terminal blocks with a 7.5 mm grid dimension; more details upon request.

Upon request, tab connections 6.3/ 2.8 x 0.8 mm; the 2, 3, and 4 position printed circuit strips with plastic ribs between the tabs can be fitted in rows in accordance with the grid spacing; to this effect the housing upper sections are supplied in a modified design on one or both sides with connection openings at the top.

Upon request with plug-in COMBICON connections when ordering economical batch sizes.

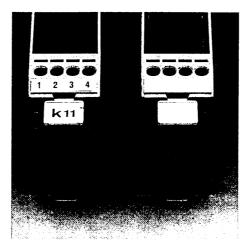
The connection components are always ked with the electronic components on e printed circuit board and are machine oldered. The upper section of the MODUCE housing ensures an aesthetically egant integration of the connection eleents.



Marking

The marking of the connection terminal blocks is made on the marking slope by standard or individually printed marking strips SKS 5 or SKS 7.5 (see catalog page 290).

Economical quantities justify direct printing; more details upon request.



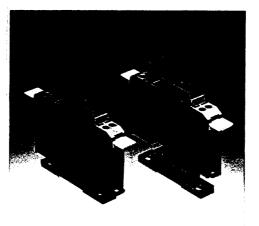
For module marking equipment marker labels EMG-GKS and EMG-SGKS are available, which can be inserted on both sides of the housing and individually marked.

Assembly

All MODUFACE modules are aligned in rows by simply engaging on the symmetrical mounting rail in accordance with DIN EN 50 022. Dismantling is made by pulling back the orange engagement latch.

To engage modules up to 30 mm width on the asymmetrical mounting rail in accordance with DIN EN 50 035 the adaptor EM-AD/NS 32 can be used.

Modules with a 12.5 and 25 mm width can also be individually mounted without a rail using a special plastic base.



mm to Inch 25 = (.984 32.5 = (1.279 55 = (2.165 62.5 = (2.461 69.5 = (3.740

Materials

Housing components and transparent cover are made of difficult to ignite thermoplastics, suitable and internationally listed for permanent temperatures up to 100°C.

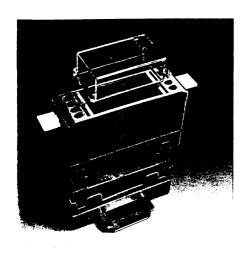
The housing protection type corresponds to IP 40; IP 20 for connection terminals.

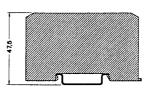
ODUFACE Range Review

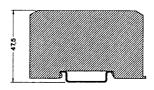
Available				MODUFACI	E covers							
Upon reque	st			H 52	H 52		H 52	H 52	H 52	H 52	H 52	H 52
				H 15	H 15	H1	H 15	H 15	H 15	H 15	H 15	H 15
				H7.5	H7.5		H7.5	H7.5	H7.5	H7.5	H7.5	H7.5
	Туре			EMG 10-H Page 8	EMG 12-H Page 8	EMD 12-H Page 15	EMG 15-H Page 9	EMG 17-H Page 9	EMG 22-H Page 9	EMG 25-H Page 10	EMG 30-H Page 10	EMG 37-H Page 11
	.,,,,	Width/s		10	12.5	12.5	15	17.5	22.5	25	30	37.5
DUFACE ic		[mm/	inch] No. of	(.394)	(.492)	(.492)	(.590)	(.689)	(.886)	(.984)	(1.181)	(1.476)
sing			positions									
	EMG 10 Page 8	10 (.394)	4	•								
	EMG 12 Page 8	12.5 (.492)	4		•							
	EMG 15 Page 9	15 (.590)	4 6				•					
	EMG 17 Page 9	17.5 (.689)	4					•				
	EMG 22 Page 9	22.5 (.886)	8						•			
	EMG 25 Page 10	25 (.984)	8		•					•		
	EMG 30 Page 10	30 (1.181)	10	•			•				•	
	EMG 37 Page 11	37.5 (1.476)	14		•							•
	EMG 45 Page 11	45 (1.772)	16				•		•			
	EMG 50 Page 11	50 (1.968)	18	•	•					•		
	EMG 75 Page 12	75 (2.953)	28		•					•		•
	EMG 90 Page 12	90 (3.543)	34	•			•		•		•	
	EMG 100 Page 13	100 (3.937)	* 38	•	•					•		
	EMG 125 Page 13	125 (4.921)	48		•					•		
	EMG 150 Page 13	150 (5.905)	56	•	•		•			•	•	•
	EMK 12 Page 14	12.5 (.492)	4									
	EMD 12 Page 15	12.5 (.492)	8			0						
	EME 45 Page 16	45 (1.772)	16	•	•					•		
	EMH 25 Page 17	25 (.984)	14									

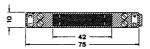
							MODUFACE connection elements					
H 52 H 15 H 7.5 MG 45-H Page 11 45 (1.772)	H 52 H 15 H 7.5 EMG 50-H Page 11 50 (1.968)	H 52 H 15 H 7.5 EMG 75-H Page 12 75 (2.953)	H 52 H 15 H 7.5 EMG 90-H Page 12 90 (3.543)	H 52 H 15 H 7.5 EMG 100-H Page 13 100 (3.937)	H 52 H 15 H 7.5 EMG 125-H Page 13 125 (4.921)	H 52 H 15 H7.5 EMG 150-H Page 13 150 (5.905)	MKDS Catalog Page 290 5 (.197)	GMKDS Catalog Page 292 7.5 (.295)	MKKDS Catalog Page 291 5 (.197)	FLIS Page 8 5 (.197)	MSTB Catalog Page 302 5 (.197)	FRONT1.5 H Info 28 Page 4 5 (.197)
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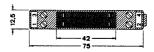
12.5 mm wide, 4 position











custom circuit modules are designed 1 solder support points allowing free ponent installation. The empty modules hout printed circuit board and connecterminal blocks) offer the possibility of ommodating electronic circuits in dust shock proof, low cost housings.

	[mm²]	AWG
Connection data, fine strand	2.5	12
Connection data, solid strand	4	12

[mm²] AWG [A] Connection data, fine strand 2.5 Connection data, solid strand 4 Tab connection 6.3/2.8 x 0.8 mm, DIN 46 249: 20/5

Order No.

ription	
ty module, for PCB insertion,	Grid 5
nal block and cover	Grid 7.5
ty module, for PCB insertion, out tab connection strip cover	
om circuit module, consisting of housing, ection terminal blocks MKDS 3 and PCB wi oldering in electronic components	th points
r, to protect components from contact and amination. Available in green or clear. ensional drawing see page 9	clear clear grenn
ed circuit board, pting electronic components page 18)	
ed circuit terminal blocks, grid 5,	2 position
oldering into the PCB see catalog page 290)	3 position 4 position
ed circuit terminal blocks, grid 7.5,	. position
oldering into the PCB see catalog page 293)	2 position
strip, with tab connection for ering into the PCB	2 position
-	

EMG 10-LG	29 47 74 7	10	EMG
			EMG EMG
EMG 10-B2	29 47 75 0	10	EMG
EMG 10-H 7.5 mm clear EMG 10-H 15 mm clear EMG 10-H 52 mm green	29 47 76 3 29 47 77 6 29 47 78 9	10 10 10	EMG EMG
P 1-EMG 10	29 47 79 2	5	P1-E
MKDS 3/2-EMG 10	17 12 34 2	50	MKD

Order No.

Type

		PKI.
EMG 12-LG	29 48 28 3	10
EMG 12-LG-FSR EMG 12-LG-FSL EMG 12-LG-FS/FS	29 44 06 7 29 44 07 0 29 44 08 3	10 10 10
EMG 12-B2	29 48 30 6	10
EMG 12-H 7.5 mm clear EMG 12-H 15 mm clear EMG 12-H 52 mm green	29 47 11 6 29 48 29 6 29 47 12 9	10 10 10
P1-EMG 12	29 47 18 7	5
MKDS 3/2	17 11 02 6	50
FLIS 2- (2-2.8-0.8) V	17 60 13 2	50
EMG-GKS	29 47 03 5	50
EM-AD/NS 32	29 49 83 9	10
EMG-ADM	29 48 59 7	10

oment marking plate tor, to snap modules

→ mounting rails, mm (.445) wide nm (.492) wide



H 7.5 mm

H 15 mm

H 52 mm

Туре

EMG-SGKS 29 47 58 5

Reduction factor dependent upon the ambient temperature

As the maximum permissible power loss is reduced with an increase in the ambient temperature, the listed reduction factor (KI) must be taken into account when calculating the permissible power loss.

EMG 10 EMG 12 EMG 15 EMG 17 EMG 22

1.4

1.6

2.3

1.3

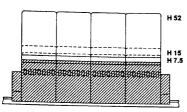
1.5

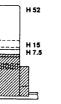
2.1

Ambient temperature (°C)					
	20	30	40	50	60
Kı	1	0.8	0.64	0.51	0.41

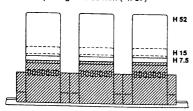
r loss dependent upon the cover at at 20° C

nted with zero spacing





nted with a spacing of ≥ 20 mm (.787)



Power loss [W] at 20° C

Power loss [W] at 20° C

0.9

1.0

1.5

1.2

1.3

2

1.2

1.4

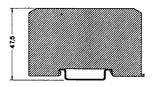
	EMG 10	EMG 12	EMG 15	EMG 17	EMG 22
H 7.5 mm	1.2	1.3	1.3	1.4	1.6
H 15 mm	1.4	1.5	1.5	1.6	1.8
H 52 mm	2.2	2.6	2.7	2.7	2.9

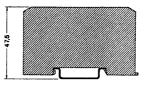
LIVIU IJ

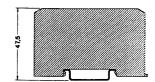
15 mm wide, 4 position with screw connection, grid 7.5 6 position with screw connection, grid 5

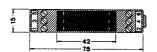
17.5 mm wide, 4 position with screw connection, grid 7.5 6 position with screw connection, grid 5

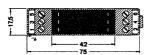
- IYI W 44 22.5 mm wide, 8 position

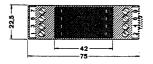












	[mm²]	AWG
onnection data, fine strand	2.5	12
onnection data, solid strand	4	12

	[mm²]	AWG
Connection data, fine strand	2.5	12
Connection data, solid strand	4	12

[mm²] AWG Connection data, fine strand Connection data, solid strand 12 12

/pe	Order No.	Pcs. Pkt.	Туре	Order No.	Pcs. Pkt.	Туре	Order No.	Pcs. Pkt.
MG 15-LG	29 47 80 2	10	EMG 17-LG	29 46 07 8	10	EMG 22-LG	29 46 13 3	10
MG 15-LG-7.5	29 44 09 6	10	EMG 17-LG-7.5	29 44 10 6	10			
MG 15-B3	29 47 81 5	10	EMG 17-B3	29 46 08 1	10	EMG 22-B4	29 46 14 6	10
MG 15-H 7.5 mm clear MG 15-H 15 mm clear MG 15-H 52 mm green	29 47 82 8 29 47 83 1 29 47 84 4	10 10 10	EMG 17-H 7.5 mm clear EMG 17-H 15 mm clear EMG 17-H 52 mm green	29 46 09 4 29 46 10 4 29 46 11 7	10 10 10	EMG 22-H 7.5 mm clear EMG 22-H 15 mm clear EMG 22-H 52 mm green	29 46 15 9 29 46 16 2 29 46 17 5	10 10 10
1-EMG 15	29 47 85 7	5	P1-EMG 17	29 46 12 0	5	P1-EMG 22	29 46 18 8	5
IKDS 3/3-EMG 15	17 12 69 8	50	MKDS 3/2 MKDS 3/3	17 11 02 6 17 11 03 9	50 50	MKDS 3/2 MKDS 3/3 MKDS 3/4	17 11 02 6 17 11 03 9 17 11 04 2	50 50 50
iMKDS 3/2-EMG 15	17 31 46 2	50	GMKDS 3/2	17 31 02 2	50			
MG-GKS	29 47 03 5	50	EMG-GKS	29 47 03 5	50	EMG-GKS	29 47 03 5	50
M-AD/NS 32	29 49 83 9	10	EM-AD/NS 32	29 49 83 9	10	EM-AD/NS 32	29 49 83 9	10

ower loss dependent upon the ambient temperature nd cover height

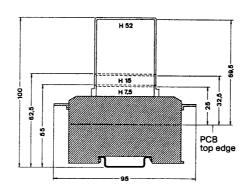
Vtu = Pvt x Kj

xplanations: Pv = power loss tu = ambient temperature t = 20° C K_I = reduction factor

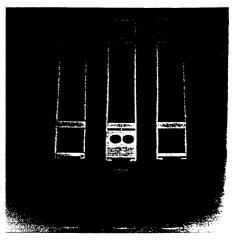
Example: Yower loss at 40° C in EMG 12, mounted without pacing, cover height H 15 mm

 v_{40}° C = Pv_{20}° C x K_I = 1.3 W x 0.64 = 0.83 W

Dimensional drawing of electronic modules EMG



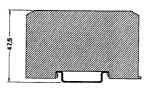
Design of the electronic modules EMG with tab connection

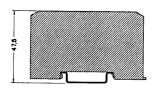


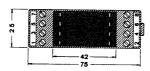
...-FS/FS ...-FSR ...-FSL

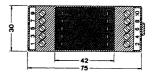
nm to inch	42 = (1.653)
7.5 = (.295)	47.5=(1.870)
0 =(.394)	52 = (2.047)
2.5=(.492)	55 = (2.165)
5 =(.590)	62.5=(2.461)
7.5=(.689)	69.5=(2.736
?2.5=(.886)	75 = (2.953)
.25 = (.984)	95 = (3.740)
32.5 = (1.279)	100 = (3.937)

30 mm wide, 10 position









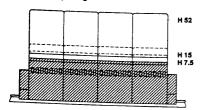
	[mm²]	AWG
Connection data, fine strand	2.5	12
Connection data, solid strand	4	12

	[mm²]	AWG
Connection data, fine strand	2.5	12
Connection data, solid strand	4	12

ription		Туре	Order No.	Pcs. Pkt.	Туре	Order No.	Pcs. Pkt.
ty module, for PCB insertion out screw connection inal block and cover	Grid 5	EMG 25-LG	29 48 31 9	5	EMG 30-LG	29 47 86 0	5
com circuit module, consisting of housing, nection terminal block MKDS 3 and PCB voldering in electronic components		EMG 25-B4	29 48 33 5	5	EMG 30-B5	29 47 87 3	5
Fr, to protect components from contact ar amination. Available in green or clear. Ensional drawing see page 11	nd clear clear green	EMG 25-H 7.5 mm clear EMG 25-H 15 mm clear EMG 25-H 52 mm green	29 47 13 2 29 48 32 2 29 47 14 5	10 10 10	EMG 30-H 7.5 mm clear EMG 30-H 15 mm clear EMG 30-H 52 mm green	29 47 88 6 29 47 89 9 29 47 90 9	5 5 5
ed circuit board, epting electronic components page 18)		P1-EMG 25	29 47 19 0	5	P1-EMG 30	29 47 91 2	5
ed circuit terminal blocks, grid 5 oldering into the PCB see catalog page 290)	2 position 3 position 4 position	MKDS 3/2 MKDS 3/3 MKDS 3/4	17 11 02 6 17 11 03 9 17 11 04 2	50 50 50	MKDS 3/2 MKDS 3/3 MKDS 3/4	17 11 02 6 17 11 03 9 17 11 04 2	50 50 50
r	narrow ormal	EMG-GKS	29 47 03 5	50	EMG-SGKS EMG-GKS	29 47 58 5 29 47 03 5	50 50
tor, to snap the module → mounting rails, mm (.445) wide		EM-AD/NS 32	29 49 83 9	10	EM-AD/NS 32	29 49 83 9	10
ptor for direct fitting mm (.492) wide		EMG-ADM	29 48 59 7	10			

er loss dependent upon the cover ht at 20° C

nted with zero spacing





	EMG 25	EMG 30	EMG 37	EMG 45	EMG 50
H 7.5 mm	1.4	1.5	1.6	2.0	2.3
H 15 mm	1.6	1.7	1.9	2.5	2.8
H 52 mm	2.3	2.4	2.6	3.5	3.8

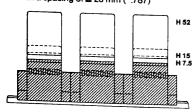
Reduction factor dependent upon the ambient temperature

As the maximum permissible power loss is reduced with an increase in the ambient temperature, the listed reduction factor (K_I) must be taken into account when calculating the permissible power loss.

Ambient temperature [° C]

	20	30	40	50	60
Kį	1	0.8	0.64	0.51	0.41

nted with a spacing of ≥ 20 mm (.787)



Power loss [W] at 20° C

	EMG 25	EMG 30	EMG 37	EMG 45	EMG 50
H 7.5 mm	1.6	1.7	1.8	2.4	2.6
H 15 mm	1.8	1.9	2.1	2.9	3.4
H 52 mm	2.9	3.1	3.5	4.4	4.8

ENIG 31

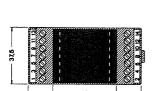
37.5 mm wide, 14 position

EIVIU 40

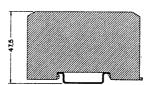
45 mm wide, 16 position

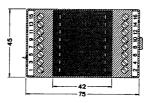
ENIG DU 50 mm wide, 18 position



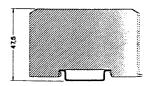


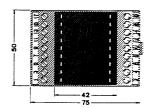
	[mm²]	AWG
onnection data, fine strand	2,5	12
onnection data, solid strand	4	12





	[mm²]	AWG
Connection data, fine strand	2.5	12
Connection data, solid strand	4	12





	[mm²]	AWG
Connection data, fine strand	2.5	12
Connection data, solid strand	4	12

/pe	Order No.	Pcs. Pkt.	Туре	Order No.	Pcs. Pkt.	Туре	Order No.	Pcs.
MG 37-LG	29 47 05 1	5	EMG 45-LG	29 46 19 1	5	EMG 50-LG	29 47 24 2	5
MG 37-B7	29 47 06 4	5	EMG 45-B8	29 46 20 1	5	EMG 50-B9	29 47 25 3	5
MG 37-H 7.5 mm clear MG 37-H 15 mm clear MG 37-H 52 mm green	29 47 15 8 29 47 16 1 29 47 17 4	5 5 5	EMG 45-H 7.5 mm clear EMG 45-H 15 mm clear EMG 45-H 52 mm green	29 46 21 4 29 46 22 7 29 46 23 0	5 5 5	EMG 50-H 7.5 mm clear EMG 50-H 15 mm clear EMG 50-H 52 mm green	29 47 92 5 29 47 93 8 29 47 94 1	5 5 5
1-EMG 37	29 47 07 7	5	P1-EMG 45	29 46 24 3	5	P1-EMG 50	29 47 25 5	5
IKDS 3/2 IKDS 3/3 IKDS 3/4	17 11 02 6 17 11 03 9 17 11 04 2	50 50 50	MKDS 3/2 MKDS 3/3 MKDS 3/4	17 11 02 6 17 11 03 9 17 11 04 2	50 50 50	MKDS 3/2 MKDS 3/3 MKDS 3/4	17 11 02 6 17 11 03 9 17 11 04 2	50 50 50
MG-GKS	29 47 03 5	50	EMG-GKS	29 47 03 5	50	EMG-GKS	29 47 03 5	50

'ower loss dependent upon the ambient temperature ind cover height

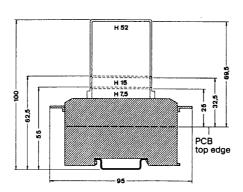
v_{tu}=Pv_t x K_l

ixplanations: Pv= power loss
tu = ambient temperature
t = 20° C
K_I = reduction factor

:xample: 'ower loss at 40° C in EMG 25, mounted without pacing, cover height H 15 mm

 v_{40} ° C = Pv_{20} ° C x K_I = 1.6 W x 0.64 = 1.02 W

Dimensional drawing of electronic module EMG



nm to inch 7.5=(.295) 5 =(.590) 25 =(.984) 30 =(1.181) 32.5=(1.279) 37.5=(1.476) 12 =(1.653) 5 =(1.777)	47.5=(1.870) 50 =(1.968) 52 =(2.047) 55 =(2.165) 62.5=(2.461) 69.5=(2.736) 75 =(2.953) 95 =(3.740)
5 = (1772)	100 = (3.937)

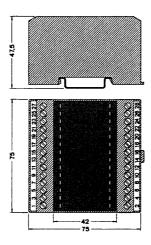
lectronic Modules EMG or Custom Circuits

EMG /5

75 mm wide, 28 position

EMG 90

90 mm wide, 34 position



AWG [mm²] Connection data, fine strand Connection data, solid strand 12 12

[mm²]

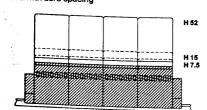
AWG

Connection data, fine strand Connection data, solid strand 12 12

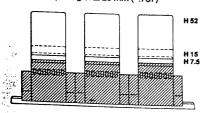
scription		Туре	Order No.	Pcs. Pkt.	Туре	Order No.	Pcs. Pkt.
npty module, for PCB insertion hout screw connection minal block and cover	Grid 5	EMG 75-LG	29 47 37 8	5	EMG 90-LG	29 46 25 6	2
stom circuit module, consisting of housing, nnection terminal block MKDS 3 and PCB with soldering in electronic components	points	EMG 75-B14	29 47 38 1	2	EMG 90-B17	29 46 26 9	5
wer, to protect components from contact and ntamination. Available in green or clear. nensional drawing see page 13	clear clear green	EMG 75-H 7.5 mm clear EMG 75-H 15 mm clear EMG 75-H 52 mm green	29 47 95 4 29 47 96 7 29 47 97 0	5 5 5	EMG 90-H 7.5 mm clear EMG 90-H 15 mm clear EMG 90-H 52 mm green	29 45 39 6 29 45 40 6 29 44 30 0	5 5 5
nted circuit board, cepting electronic components se page 18-19)		P1-EMG 75	29 47 39 4	5	P1-EMG 90	29 46 27 2	5
inted circuit terminal blocks, grid 5, soldering into the PCB so see catalog page 290)	2 position 3 position 4 position	MKDS 3/2 MKDS 3/3 MKDS 3/4	17 11 02 6 17 11 03 9 17 11 04 2	50 50 50	MKDS 3/2 MKDS 3/3 MKDS 3/4	17 11 02 6 17 11 03 9 17 11 04 2	50 50 50
ulpment marking plate		EMG-GKS	29 47 03 5	50	EMG-GKS	29 47 03 5	50

wer loss dependent upon the cover ight at 20° C

runted with zero spacing



ounted with a spacing of ≥ 20 mm (.787)



Power loss [W] at 20° C

	EMG75	EMG90	EMG100	EMG125	EMG150
H 7.5 mm	3.3	4.1	-	-	-
H 15 mm	3.8	5.0	-	-	
H 52 mm	4.9	6.1	-	-	-

Power loss [W] at 20° C

	EMG75	EMG90	EMG100	EMG125	EMG150
H 7.5 mm	3.9	4.6	-	-	-
H 15 mm	4.8	5.7	-	-	-
H 52 mm	5.8	7.1	-	-	-

Reduction factor dependent upon the ambient temperature

As the maximum permissible power loss is reduced with an increase in the ambient temperature, the listed reduction factor (Kj) must be taken into account when calculating the permissible power loss.

Ambient temperature [° C]					
	20	30	40	50	60
Kı	1	0.8	0.64	0.51	0.41

ENIG IUU

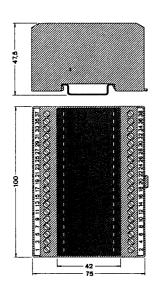
100 mm wide, 38 position

ENIG 120

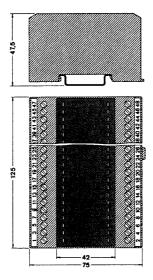
125 mm wide, 48 position

EIVIG 100

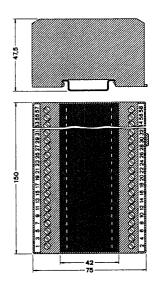
150 mm wide, 58 position



[mm²] AWG Connection data, fine strand Connection data, solid strand 12 12



[mm²] **AWG** Connection data, fine strand Connection data, solid strand 12 12



[mm²] AWG Connection data, fine strand Connection data, solid strand 12 12 2.5 4

Гуре	Order No.	Pcs. Pkt.	Туре	Order No.	Pcs. Pkt.	Туре	Order No.	Pcs Pkt
EMG 100-LG	29 47 08 0	2	EMG 125-LG	29 47 98 3	2	EMG 150-LG	29 46 02 3	2
EMG 100-B19	29 47 09 3	2	EMG 125-B24	29 47 99 6	2	EMG 150-B29	29 46 03 6	2
on request			on request			on request		
² 1-EMG 100	29 47 10 3	5	P1-EMG 125	29 46 01 0	5	P1-EMG 150	29 46 04 9	5
MKDS 3/2 MKDS 3/3 MKDS 3/4	17 11 02 6 17 11 03 9 17 11 04 2	50 50 50	MKDS 3/2 MKDS 3/3 MKDS 3/4	17 11 02 6 17 11 03 9 17 11 04 2	50 50 50	MKDS 3/2 MKDS 3/3 MKDS 3/4	17 11 02 6 17 11 03 9 17 11 04 2	50 50 50
EMG-GKS	29 47 03 5	50	EMG-GKS	29 47 03 5	50	EMG-GKS	29 47 03 5	5 0

Power loss dependent upon the ambient temperature and cover height

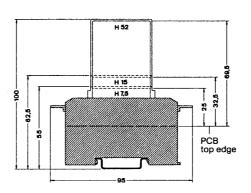
Pvtu = Pvt x Kı

Explanations: Pv = power loss
tu = ambient temperature
t = 20° C
K_I = reduction factor

Example:
Power loss at 40° C in EMG 90; mounted without spacing; cover height H 15 mm

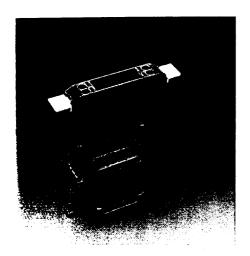
 Pv_{40}° C = Pv_{20}° C x K_I = 5.0 W x 0.64 = 3.2 W

Dimensional drawing of electronic module EMG

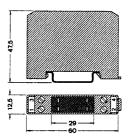


ectronic Module EMK r Custom Circuits

12.5 mm wide, 4 positions



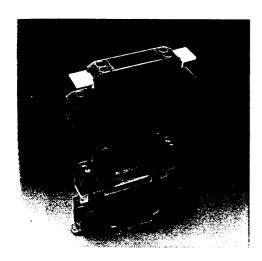
The special feature of the electronic odule EMK is its compact design with ly 12.5 mm construction width.

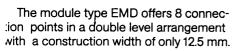


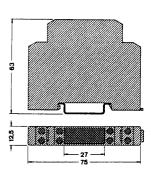
[mm²] AWG
Connection data, fine strand
Connection data, solid strand
4 12

Description	Туре	Order No.	Pcs. Ptk.
Empty module, for PCB insertion, without screw connection terminal block	EMK 12-LG	29 48 98 2	10
Custom circuit module, consisting of housing, connection terminal blocks MKDS 3 and PCB with points for soldering in electronic components	EMK 12-B2	29 48 99 5	10
Printed circuit board, to mount electronic components (see page 19)	P1-EMK12	29 47 01 9	5
Printed circuit terminal blocks, for soldering into the PCB 2 positions (also see catalog page 290)	MKDS 3/2	17 11 02 6	50
Equipment marking plate	EMG-GKS	29 47 03 5	50
Adaptor, to snap the module on ☐ mounting rails, 11.4 mm (.445) wide	EM-AD/NS 32	29 49 83 9	10
Adaptor for direct fitting 12.5 mm (.492) wide	EMG-ADM	29 48 59 7	10

Jouble Level Electronic Module EMD for Custom Circuits



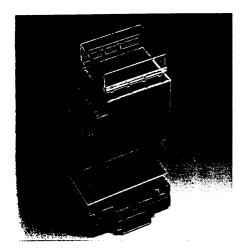




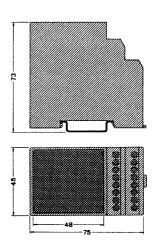
	[mm²]	AWG
Connection data, fine strand	2.5	12
Connection data, solid strand	4	12

Description		Туре	Order No.	Pcs Pkt
Empty module, for PCB insertion, without screw connection terminal blocks and cover		EMD 12-LG	29 47 40 4	1C
Cover, to protect components from contact and contamination		on request		
Printed circuit terminal blocks, for soldering in the PCB bottom lower level	2 positions	MKDS 3/2	17 11 02 6	5 C
Printed circuit terminal blocks, for soldering in the PCB upper level	2 positions	MKKDSH 3/2	17 21 04 5	5 C
Spacer, plastic for the printed circuit terminal blocks MKKDSH		AH-MKKDSH 3/2	17 21 78 6	5 C
Equipment marking plate		EMG-GKS	29 47 03 5	5 C
Adaptor, to snap the modules on mounting rails, 11.4 mm (.445) wide		EM-AD/NS 32	29 49 83 9	10
Adaptor for direct fitting 12.5 mm (.492) wide		EMG-ADM	29 48 59 7	10

ouble Level ectronic Module EME r Custom Circuits



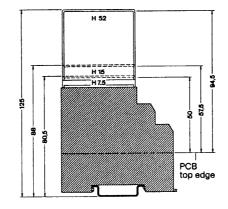
The module type EME offers an enlarged stom circuit space. The 16 connection ints are arranged on only one side of the odule on both levels as input or output minal blocks.



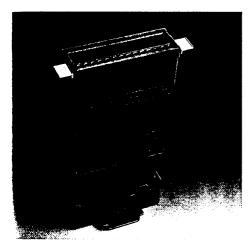
	[mm²]	AWG
Connection data, fine strand	2.5	12
Connection data, solid strand	4	12

Description		Туре	Order No.	Pcs.
Empty module, for PCB insertion, without screw connection terminal blocks and cover		EME 45-LG	29 44 11 9	10
Cover , to protect components from contact and contamination. Available in green or clear, see below for dimensions	clear	EMG 50-H 7.5 mm clear	29 47 92 5	5
	clear	EMG 50-H 15 mm clear	29 47 93 8	5
	green	EMG 50-H 52 mm green	29 47 94 1	5
Printed circuit terminal blocks , grid 5, for soldering in the PCB	2 position	MKKDSG 3/2	17 21 09 0	50
	3 position	MKKDSG 3/3	17 21 08 7	50

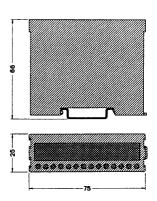
Dimensional drawing of electronic module EME



nm to inch 7.5=(.295) 15 = (.590) 45 = (1.772) 48 = (1.890) 50 = (1.968) 52 = (2.047) 57.5=(2.264) 73 = (2.874) 80.5=(3.169) 88 = (3.464) 94.5=(3.720) 25 = (4.921)



These component housings with front connection system have a variable construction height. With a construction width of only 25 mm, the required module height and thus the custom circuit space can be lexibly varied by the use of intermediate elements. In this manner the vertically arranged PCB in the module can be matched to the individual switching task. 14 individual printed circuit terminals with front connection are fitted in the module. Each connection point can also be allocated a light indicator.



	[mm²]	AWG
Connection data, fine strand	1.5	16
Connection data, solid strand	1.5	16

Description	Туре	Order No.	Pcs Pkt
Empty module, for PCB insertion, without screw connection terminal blocks	EMH 25-LG	29 44 12 2	10
Intermediate elements, for the empty module intermediate element, 18 mm high intermediate element, 30 mm high	EMH 25-ZE 18 EMH 25-ZE 30	29 44 13 5 29 44 14 8	10 10
Single printed circuit terminal block, for front connection, 5 mm grid, pin spacing 5 mm pin spacing 10 mm	FRONT1.5H/SA5 FRONT1.5H/SA10	17 00 00 8 17 00 04 0	50 50
End cover, necessary at the end of a terminal block row, 2,5 mm thick, color: green	D-FRONT1.5H	17 00 02 4	50
Equipment marking plate	EMG-GKS	29 47 03 5	50
Adaptor to snap the module on mounting rails, 11.4 (.445) mm wide	EM-AD/NS 32	29 49 83 9	10
Adaptor for direct fitting 12.5 (.492) mm wide	EMG-ADM	29 48 59 7	10

Dimensional drawing of electronic module EMH

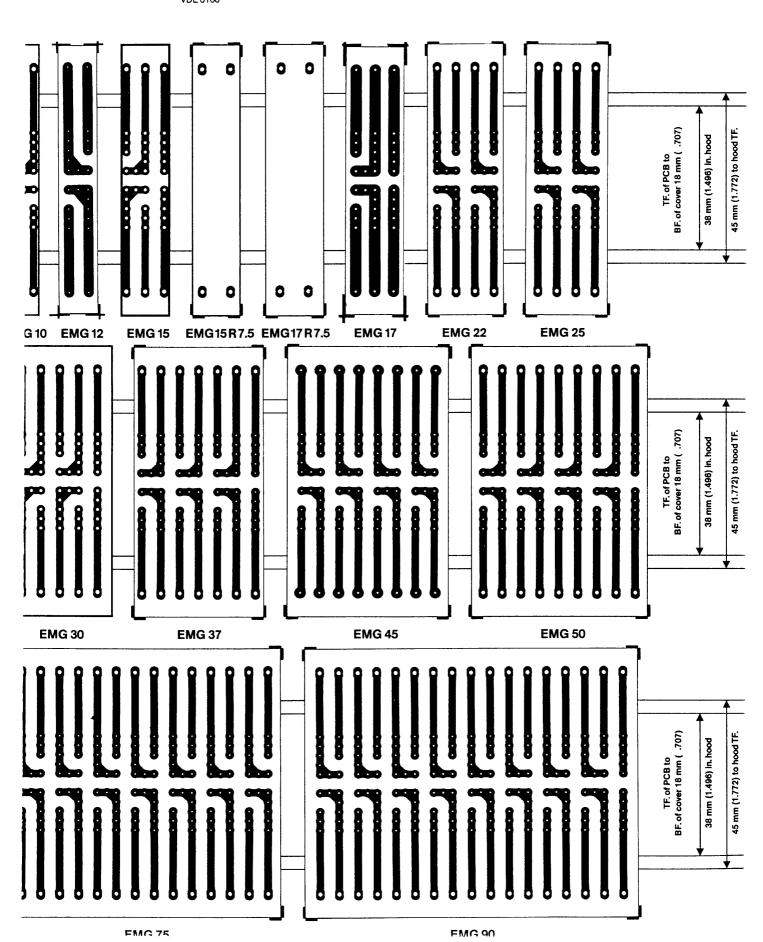


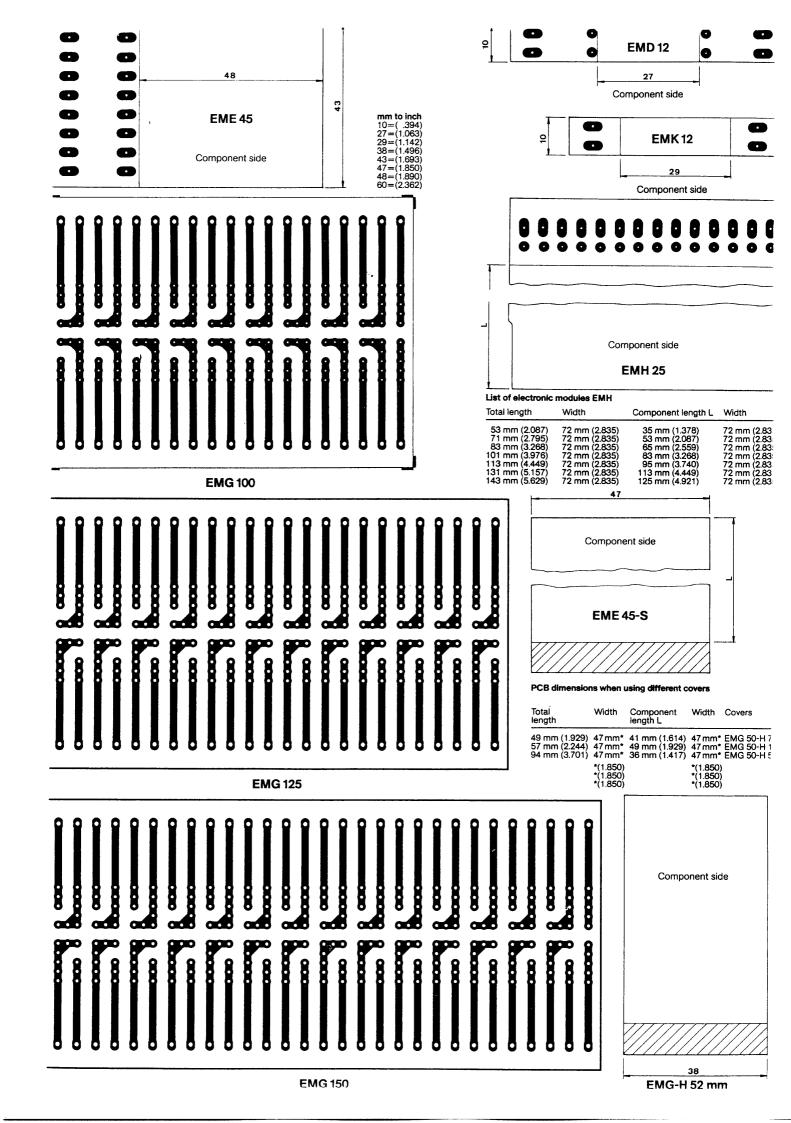
inted Circuit Board Layouts for the Electronic Modules EMG, EMK, EMD, EME and VIH in a 1:1 Scale

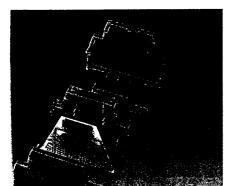
TF. ← Top face BF. ← bottom face in. ← internal

nnical data for the printed circuit board

ic material: Epoxy glass filament fabric
1.5 mm (.026) thick as per DIN 40802
15er plating: 70 µm
3s: 1.3 mm (.051) dia for the solder pins of
the screw and tab connections
0.9 mm (.035) dia for components as per DIN 40801 page 2
1nd creepage distance: 250 V AC as per VDE 0110/Gr. C
VDE 0160



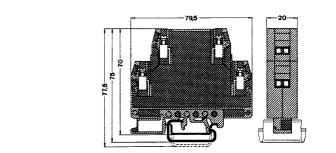




Type of moldings

Polyamide 6.6, see catalog page 12 Color: green

Marking and mounting material see catalog page 10



he electronic component housing UEG roduced in two widths (20 and 30 mm) 1 screw or tab connections. The housing be engaged on commercially available I EN mounting rails.

he functionable housing concept per-3 an economical production of series s. In one work cycle the basic element 1 the connections and the custom cired PCB are machine soldered and subuently securely engaged with the housshells to form a housing. Due to the ible level 8 or 16 screw or tab connecs and the installation of one or two ited circuit boards even complex elecnic circuits can be accommodated in the ısina.

or laboratory samples and small series a /ersal printed circuit board is available.

or technical data and of the printed cirboard dimensions refer to page 26.

		fine strand, [mm²]	AWG	[A]	VAC [V]
crew connection ab connection: 6.3/2	4 8 mm	2.5	12	10*	250*
EG 20-FS/FS	.0			10/5*	500*
IEG 30/1-FS/FS				10/5*	
IEG 30/2-FS/FS				10/5*	250*

UEG 30/2-FS/FS

*The rated voltage applies to fully insulated receptacles and free solder connection. Voltage and current values are affected by the configuration of the printed circuit





Electronic component housing, 20 mm wide, complete, equipped with 4 screw or 4 tab connections per side, for one printed circuit board

Electronic component housing, 30 mm wide, complete, equipped with 4 screw or 4 tab connections per side, for one printed circuit board

Electronic component housing, 30 mm wide, complete, equipped with 8 screw or 8 tab connections per side, for two printed circuit boards

Printed circuit board, for custom circuiting electronic components (see page 26)

Plastic sheath, as shock protection, slide onto conductor for 6.3 mm receptacles before fitting for 2.8 mm receptacles

Wire bridge, 50 position, divisible, for bridging identical inputs and outputs, 0.5 mm², insulation: black or gray



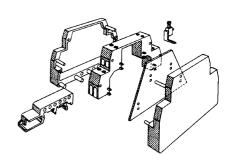
Power loss as a function of ambient temperature

Mounted with zero spacing Power loss [W] at 20° C

UEG 20	UEG 30/1	UEG 30/2	UEG 20- FS/FS	UEG 30/1- FS/FS	UEG 30/2- FS/FS
4	4	4	4.8	4.8	4.8

Mounted with spacing of ≥ 20 mm Power loss [W] at 20° C

UEG 20	UEG 30/1	UEG 30/2	UEG 20- FS/FS	UEG 30/1- FS/FS	UEG 30/2- FS/FS
64	72	7.2	8	8	8



UEG 20

Туре	Order No.	Pcs.	
.,,,,	51451 1151	Pkt.	
UEG 20	27 90 21 1	10	

P1-UEG 27 90 22 4 10

DB 50-90 black DB 50-90 grey

Reduction factor dependent upon the ambient

As the maximum permissible power loss is reduced with an increase in the ambient temperature, the listed reduction factor (K_{\parallel}) must be taken into account when calculating the permissible power loss.

Ambient temperature [º C]

		30					
Κį	1	0.78	0.61	0.48	0.37	0.29	0.23

Power loss dependent upon the ambient temperature

Pvtu=Pvt x KI

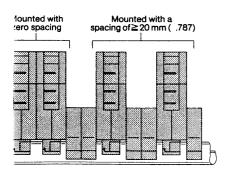
Explanations:

= power loss
= ambient temperature 20° C

= 20° C = reduction factor

Example: Power loss at 40° C in UEG 20, mounted without

 $P_{V40^{\circ}} C = P_{V20^{\circ}} C \times K_{I} = 4 W \times 0.61 = 2.44 W$

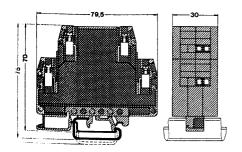


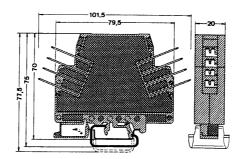
UEG 20-FS/FS

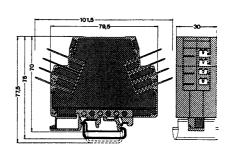
8 position component holder with slotted 6.3/2.8 mm tab connection

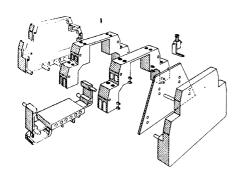
UEG 30-FS/FS

8 and 16 position component holder with slotted 6.3/2.8 mm tab connection

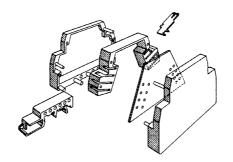




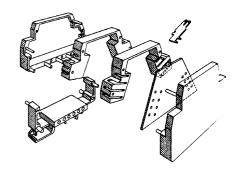








UEG 20-FS/FS



u	EG	30	/1-	FS.	/FS

pe	Order No.	Pcs. Pkt.	Туре	Order No.	Pcs. Pkt.	Туре	Order No.	Pcs. Pkt.
			UEG 20-FS/FS	27 90 26 6	10			
EG 30/1	27 90 87 1	10				UEG 30/1-FS/FS	27 90 88 4	10
EG 30/2	27 90 24 0	10				UEG 30/2-FS/FS	27 90 27 9	10
I-UEG	27 90 22 4	10	P1-UEG-FS/FS	27 90 42 8	10	P1-UEG-FS/FS	27 90 42 8	10
			PT/FS-6.3 PT/FS-2.8	06 04 70 7 14 06 70 0	100 100	PT/FS-6.3 PT/FS-2.8	06 04 70 7 14 06 70 0	100 100
8 50-90 black 8 50-90 grey	28 20 91 6 28 20 92 9	1 1						

aximum component height on printed circuit board

UEG 20 Usith in 1 printed in circuit soard, max. 1 8 positions of

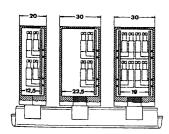
IVEG 30/1 UEG increased increr internal space with 1 printed 2 prir circuit board, max. 8 position internal space with 1 printed 2 prir circuit board, max. 8 position internal space with 1 printed 2 prir circuit board, max. 8 position internal space with 1 printernal sp

UEG 30/2 increased internal space with 2 printed circuit boards, mirror image arrangement, max. 16 positions

Maximum component height on printed circuit board

UEG 20-FS/FS with increased internal circuit board, max. 8 positions UEG 30/1-1 printed internal space with board, max. 8 position

UEG 30/2-FS/FS increased internal space with 2 printed circuit boards, mirror image arrangement, max. 16 positions

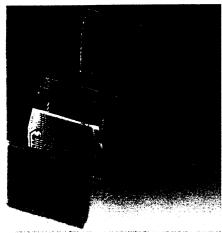


\$ 2555 x	30 5 5 5 5 -225	\$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$ \$
2.5	- 22,5 -	19-19-1

mm to inch
20 = (.787)
30 = (1.181)
70 = (2.756)
75 = (2.953)
77.5 = (3.051)
79.5 = (3.130)
101.5 = (3.996)

6 position component holder with screw connection

ousings UEGM r Custom Circuits

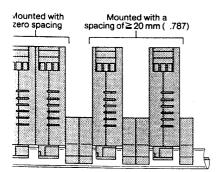


he electronic component housings GM supplement the UEG range and ofan enlarged internal area. The housing vailable in the widths 22.5 - 25 and mm. They can be individually provided in screw and/or tab connections. The usings snap on commercially available I EN mounting rails.

The functionable housing concept pers the economical production of series ts. In one work cycle the basic element nachine soldered with the connections I the custom circuited PCB and subseently securely engaged with the housing Il to form a housing. Due to the double el 6 or 12 screw or tab connections and use of one or two printed circuit boards en complex electronic circuits can be acnmodated in the housing.

For laboratory samples and small series a versal printed circuit board is available.

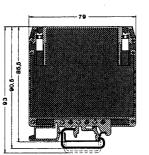
For technical data and printed circuit ard dimensions refer to page 26.

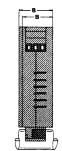


Type of moldings

= Polyamide 6.6, see catalog page 12 Color: green

Marking and mounting material see catalog page 10





W=22.5 with UEGM 22.5 W=25 with UEGM 25

Order No.

06 04 70 7 14 06 70 0

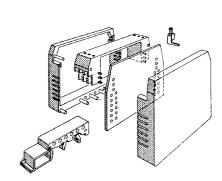
28 20 91 6 28 20 92 9

100 100

Solid, fine strand, AWG VAC [V] [À] [mm²]

10* 250* 10/5* 250*

Screw connection 4 2.5 12 10* 2:
Tab connection: 6.3/2.8 mm 10/5* 2:
*The rated voltage applies to fully insulated receptacles and free solder connection. Voltage and current values are affected by the configuration of the printed circuit



UEGM 25

Type

Description **Electronic component housing,** 22.5 mm wide, complete, equipped with 3 screw or 6 tab connections per side, for one printed circuit board Electronic component housing as above, however, 25 mm wide Electronic component housing as above, however 40 mm wide

Electronic component housing, 40 mm wide, complete, equipped with 6 screw or 12 tab connections per side, for two printed circuit boards.

Printed circuit board, for custom circuiting electronic components (see page 26)

Metal part for tab connection, to increase the number of positions

3

Plastic sheath, as shock protection, slide onto conductor for 6.3 mm receptacles before fitting for 2.8 mm receptacles

Wire bridge, 50 position, divisible for bridging identical inputs and outputs, 0.5 mm², insulation: black and grey



Power loss as a function of ambient

Mounted with zero spacing Power loss [W] at 20° C

U1	EGM 22.5	UEGM 25	UEGM 40/1	UEGM 40/2	UEGM 22.5- FS/FS	UEGM 25- FS/FS	UEGM 40/1- FS/FS	UEGM 40/2- FS/FS
	4	4	5.2	5.2	4	4	5.2	5.2

Mounted with spacing of ≥ 20 mm power loss [W] at 20° C

UEGM 22.5	UEGM 25	UEGM 40/1	UEGM 40/2	UEGM 22.5- FS/FS	UEGM 25- FS/FS	UEGM 40/1- FS/FS	UEGM 40/2- FS/FS
10	10	11.2	11.2	10	10	11.2	11.2

Reduction factor dependent upon the ambient

As the maximum permissible power loss is reduced with an increase in the ambient temperature, the listed reduction factor ($K_{\rm I}$) must be taken into account when calculating the permissible power loss.

Ambient temperature [° C]

	20			1			
Kı	1	0.8	0.64	0.51	0.41	0.33	0.26

Power loss dependent upon the ambient

Pvtu = Pvt x Ki

DB 50-90 black DB 50-90 grey

Explanations:

Pv = power loss tu = ambient temperature t = 20° C

 $t = 20^{\circ} \text{ G}$ $K_1 = \text{reduction factor}$

Example: Power loss at 40° C in UEGM 25, mounted without

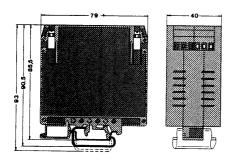
 $P_{V40^{\circ}}$ C = $P_{V20^{\circ}}$ C x K₁ = 4 W x 0.64 = 2.56 W

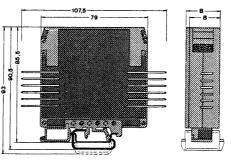
ULGIN I U/I

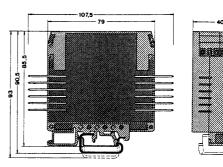
12 position component holder with slotted 6.3/2.8 tab connection

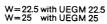
ULUIVI"I U/I U

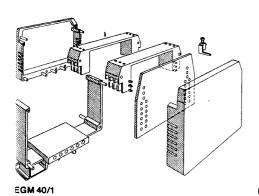
12 and 24 position component holder with slotted 6.3/2.8 mm tab connection

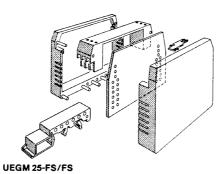


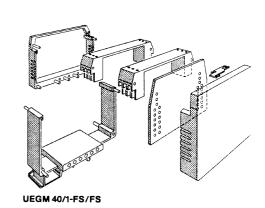










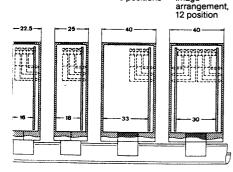


pe	Order No.	Pcs. Pkt.	
EGM 40/1	27 92 11 2	10	
∂GM 40/2	27 92 02 8	10	
I-UEGM	27 92 10 9	10	
EG-MT-FS	27 90 38 9	100	
ſ/FS-6.3 ſ/FS-2.8	06 04 70 7 14 06 70 0	100 100	
3 50-90 black B 50-90 grey	28 20 91 6 28 20 92 9	1	

Туре	Order No.	Pcs. Pkt.	Туре		Order No.	Pcs. Pkt.
UEGM 22.5-FS/FS	27 92 07 3	10				
UEGM 25-FS/FS	27 92 08 6	10				
			UEGM 40/1-	FS/FS	27 92 12 5	10
			UEGM 40/2-	FS/FS	27 92 09 9	10
P1-UEGM	27 92 10 9	10	P1-UEGM	179-054.	27 92 10 9	10
PT/FS-6.3 PT/FS-2.8	06 04 70 7 14 06 70 0	100 100	PT/FS-6.3 PT/FS-2.8		06 04 70 7 14 06 70 0	100 100

aximum component height on printed circuit board

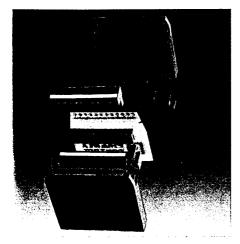
annum compenent neight on printed circuit board				
EGM 22.5 th printed cuit ard, positions	UEGM 25 with 1 printed circuit board 6 position	UEGM 40/1 increased internal space with 1 printed circuit board, 6 positions	UEGM 40/2 increased internal space with 2 printed circuit boards, image arrangement.	



Maximum component height on printed circuit board

UEGM 22.5- FS/FS with 1 printed circuit board, 12 positions	UEGM 25- FS/FS with 1 printed circuit board, 12 position	in s s c	JEGM 40/1- FS/FS ncreased nternal pace with printed ircuit poard, 2 position	UEGM 40/2- FS/FS increased internal space with 2 printed circuit boards, image arrangement
- 16 -	25		33 —	24 position

ectronic Component ousing with 12 Position **DMBICON Header EGM-MSTB**



The special feature of this 25 mm wide ctronic component housing UEGM-TB is the plug-in connection through a)MBICON plug connector 2 or 12 posi-1 COMBICON plugs can be optionally inrated in the housing pin strip.

The COMBICON connection points can individually fitted with 3 mm dia. LEDS ad length 30 mm (1.181)]. The LED ak-outs in the housing not required can closed with plugs. If several component usings with the same plug arrangement arranged next to each other, the ividuality of the COMBICON plugs can ensured by keying. For this purpose the I keying pin CS-MSTB is inserted in the cket and the corresponding contact pin ken off with the keying clippers. Using : blind piece MSTB-BL individual contact s can be covered in order to achieve a mpartment formation on the pin strip.

The electronic component housing :GM-MSTB snaps on commercially availle DIN EN mounting rails.

For technical data and printed circuit ard dimensions refer to page 27.

ver loss dependent upon the ambient perature see page 22.

same power loss is applicable as with stronic component housings UEGM 25.

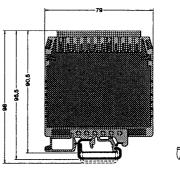
Type of moldings

= Polyamide 6.6, see catalog page 12 Color: green krilen

Marking and mounting material see catalog page 10

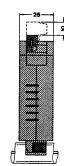
Maximum component height on the printed circuit board





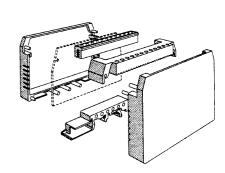
UEGIVITIVIOID

Component housing with COMBICON connection



, fine strand, AWG [mm²]

Connection data 2.5 2.5 14
Voltage and current values are affected by the configuration of the printed circuit board. 12 250*

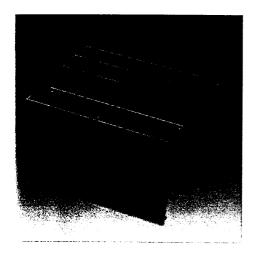


Description	No. of positions	Туре	Order No.	Pcs. Pkt.
Electronic component housing, with 12 position COMBICON pin strip, additionally fitted with 3 mm LED light indicator	12	UEGM-MSTB	27 81 45 3	10
COMBICON header, 5.08 mm grid for other COMBICON plug types see catalog page 302	2 3	MSTB 1.5/2-ST-5.08 # 179039 MSTB 1.5/3-ST-5.08	17 57 01 9 17 57 02 2	50 50
18,2 a + 5 (a + 5,08)	4 5 6	MSTB 1.5/4-ST-5.08 MSTB 1.5/5-ST-5.08 MSTB 1.5/6-ST-5.08	17 57 03 5 17 57 04 8 17 57 05 1	50 50 50
9	7 8 9	MSTB 1.5/7-ST-5.08 MSTB 1.5/8-ST-5.08 MSTB 1.5/9-ST-5.08	17 57 06 4 17 57 07 7 17 57 08 0	50 50 50
8.3 2.5 5 (2.54) (5.08)	10 12	MSTB 1.5/10-ST-5.08 MSTB 1.5/12-ST-5.08 (79040	17 57 09 3 17 57 11 6	50 50
(1) Blind piece , for coding and compartment formation, plugs onto pole pin, green plastic	A	MSTB-BL	17 55 47 7	100
(2) Keying pin, engages in the plug contact, remove counter pole in the housing, red plastic	1	CS-MSTB	17 59 99 4	100
(3) Plugs , for closing LED positions not in use		UEGM-MSTB-BS	27 81 46 6	60
(4) Keying pilers , for snipping contact pins, if the keying pin CS-MSTB is fitted in the plug		MSTB-ZA	17 67 60 1	1
(5) Marking card, with 25 pcs. 10 section white marking strips, self adhesive, sufficient for 250 terminals a) unprinted: for use with marker pen b) printed: with 25 identical decades c) card, with 50 pcs. 5 section marking strips sufficient for 250 terminals		a) SKS 5: unprinted b) SKS 5: 1-10 SKS 5: 11-20 etc.up to SKS 5: 191-200	14 01 20 0 14 01 21 3	10
printed: with L1, L2, L3, N, PE U, V, W, N, ↓	(Passes)	c) SKS 5: L1-N, PE SKS 5: U-N	14 02 27 0 14 01 28 4	
(6) Marker pen, for individual labelling of unprinted SKS 5		B-Pen	10 51 99 3	1

COMBICON plug connectors may only be actuated when not under power. If for technical operating reasons smaller loads are to be switched, experience values are available upon request.

mm to i	nch
3.6=(
10 =(
18 =(.70
25 =(
79 =(
90.5=(
95.5=(3 98 = <i>(</i> 3	

lectronic Component lousings for European ormat Cards UEG-EU



The rail mountable component housing EG-EU has been specially designed to reeive European format cards. The printed rcuit board is directly fixed in the housing iddle section and the housing closed with vo side elements. The positions of the fixg holes on the printed circuit board are ne same as for fixing high position plug onnectors onto the printed circuit board so see DIN 41612/part 1. In the middle ection break-outs can be punched for the onnection elements, whereby both high osition plug connectors as well as electroc printed circuit terminal blocks can be sed.

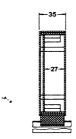
For technical data and printed circuit oard dimensions see page 27.

Type of moldings

 Polyamide 6, see catalog page 12 Color: green krilen

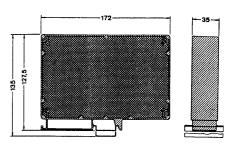
Marking and mounting material see catalog page 10

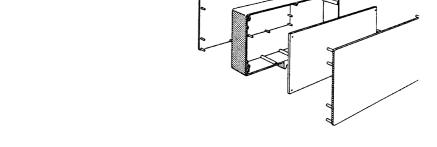
Maximum component height on the printed circuit board with 1 basic element



UEG-EU

Component housing for European format cards





Туре	Order No.	Pcs.
UEG-EU-BE	29 56 81 9	5
UEG-EU-SE	29 56 82 2	5
UEG-EU-VS	50 28 88 3	100

Description

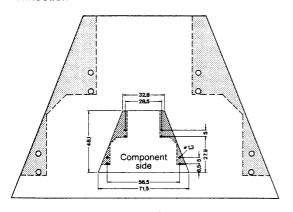
Electronic component housing, comprising: basic element with snap foot, for fitting on ____, 32 mm (1.260) wide.

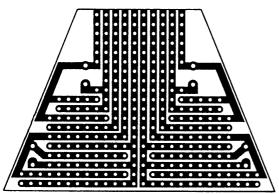
Side element, two pieces, for covering the basic element on both sides, 1.5 mm (.059) thick

Connection pin, for engaging several basic elements to form one unit; 12 necessary per element, brass

inted Circuit Board Layouts for the Electronic Component Housings UEG, UEGM, EGM-MSTB, UEG-EU in a 1:1 Scale

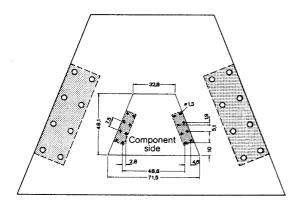
mponent Housing UEG nted Circuit Board for Component Housings with tew Connection

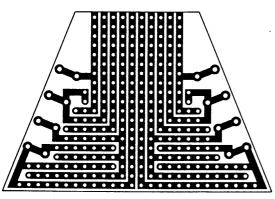




Printed Circuit Board P1-UEG

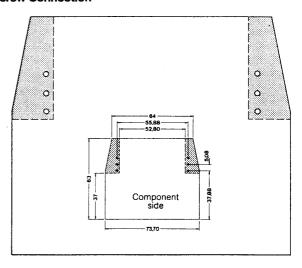
nted Circuit Board for Component Housings with Connection



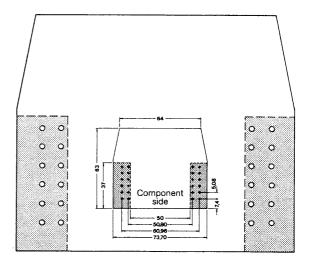


Printed Circuit Board P1-UEG-FS/FS

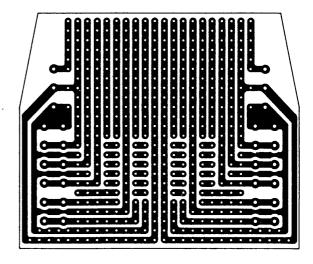
Component Housing UEGM Printed Circuit Board for Component Housings with Screw Connection



Printed Circuit Board for Component Housings with Tab Connection



Printed Circuit Board P1-UEGM for Screw and Tab Connection

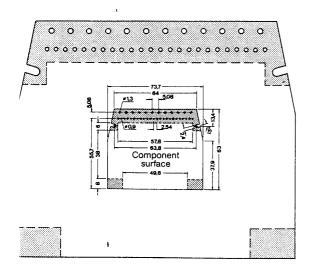


Technical data for the printed circuit board

Basic material: epoxy glass filament fabric 1.5 mm (.059) thick as per DIN 40 802 Copper plating: 70 μm Conductor path width: 2 mm (.0790) Air and creepage distance: 125 V AC as per VDE 0110/Gr. C

Holes: 1.3 mm (.051) dia. for the solder pins of the screw and tab connections 0.9 mm (.035) dia. for the components as per DIN 40801 page 2

Component Housing UEGM-MSTB

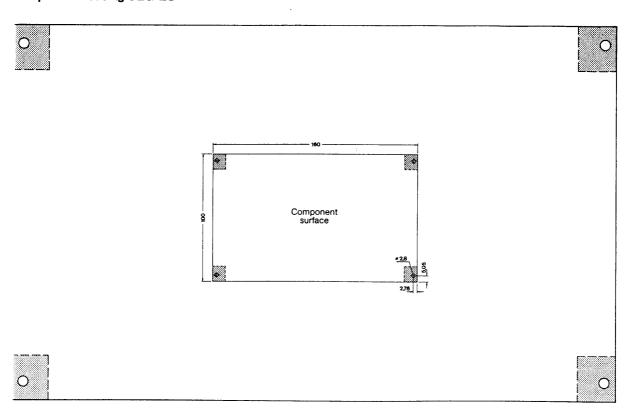


echnical data for the printed circuit board

lasic material: epoxy glass filament fabric
1.5 mm (.059) thick as per DIN 40802
copper plating: 70 µm
loles: 1.3 mm (.051) dia. for the solder pins of the COMBICON header
0.9 mm dia. for the components as per DIN 40801 page 2

mm to inch	
0.9 = (.035)	37 = (1.457)
1.3 = (.051)	37.88=(1.491)
1.9 = (.075)	37.9 =(1.492)
2.4 = (.094)	
	38 = (1.496)
2.54=(.100)	48.1 = (1.894)
2.76 = (.109)	48.8 = (1.912)
2.8 = (.110)	49.8 = (1.961)
4.6 =(.181)	50 = (1.968)
5 =(.197)	50.8 = (2.000)
5.05=(.199)	52.8 = (2.079)
5.08=(.200)	55.7 = (2.193)
5.1 = (.201)	55.88=(2.200)
6 = (.236)	56.5 = (2.224)
6.5 = (.256)	57.8 = (2.275)
7.4 = (.291)	60.96=(2.400)
	63 = (2.480)
8 =(.315)	63.8 = (2.512)
10 = (.394)	64 = (2.520)
13.4 = (.527)	71.5 = (2.815)
27.9 = (1.098)	73.7 = (2.901)
28.5 = (1.122)	100 = (3.937)
32.8 = (1.291)	160 = (6.299)

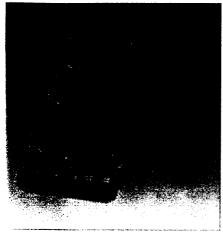
Component Housing UEG-EU



Technical data for the printed circuit board

3asic material: epoxy glass filament fabric
1.5 mm (.059) thick as per DIN 40802
Copper plating: 70 µm
Ioles: 1.3 mm (.051) dia. for the solder pins of the
screw and tab connections.
0.9 mm (.035) dia. for the components as per DIN 40801 page 2

mpact Custom Circuit odules UMK



he compact custom circuit module K is used where simple adaption and inconnection functions as well as compresive electronic circuits require individual rail mountable installation. They are nprised of various single elements with aring dimensions and functions. Depend upon the desired module size and the uired space requirement, the various indual elements are linked together to n a module. The PC board base modules K are available in a 22.5 – 33.75 – 45 etc.

wo side elements each 11.25 mm wide duce – when engaged – the smallest dule of 22.5 x 77 mm. Due to the adding sibility of the various base elements of 25 – 22.5 or 45 mm width the individually uired module dimensions are created. Dendent upon the module size one or eral foot elements are to be provided.

dvantages:

ast assembly due to the plug in modular rrinciple. The tight engagement of the inlividual elements ensures a high conection strength.

Due to the universal foot the module naps on commercially available DIN EN nounting rails.

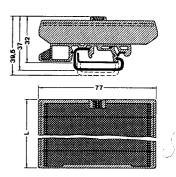
he modules can either be marked using ne labeling grooves in the side elements or using the Phoenix module marking 'MB, which snaps in a hole (4 mm dia.) the printed circuit board.

Vide range of connection possibilities or the external conductor connections lue to the large selection of electronic printed circuit boards, the screw, tab connections, the COMBICON plug connector etc. (see catalog page 290).

Type of moldings

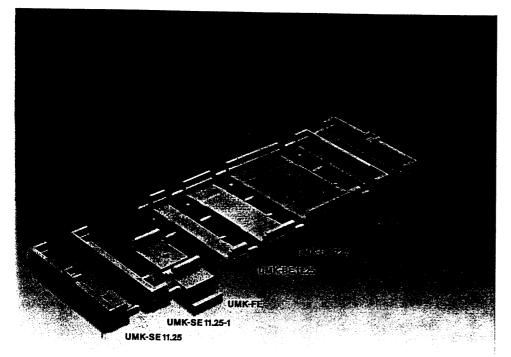
krilen = Polyamide 6.6, see catalog page 12 Color: green

Marking and mounting material see catalog page 10



mm to inch 32 =(1.260) 37 =(1.457) 39.5=(1.555) 77 =(3.031)

Description		Туре	Order No.	Pcs.
Universal module, comprising of: Side element 11.25 mm (.443) wide, with label groove		UMK-SE 11.25	29 70 00 2	10
Side element, 11.25 mm (.443) wide, without label groove		UMK-SE 11.25-1	29 70 44 2	10
Base element, 11.25 mm (.443) wide		UMK-BE 11.25	29 71 53 5	10
Base element, 22.5 mm (.886) wide		UMK-BE 22.5	29 70 02 8	10
Base element, 45 mm (1.772) wide		UMK-BE 45	29 70 01 5	10
Foot element, for mounting on orr, slideable between base and side elements	والمالي	UMK-FE	29 70 03 1	10



Assembly drawing of the universal module UMK

PCB dimensions [mm]	Module length L [mm]	Side element UMK-SE	Base element UMK-BE 11.25	Base element UMK-BE 22.5	Base element UMK-BE 45	Foot element UMK-FE
20.00×72×1.5 31.25×72×1.5 42.50×72×1.5 53.75×72×1.5 65.00×72×1.5 76.25×72×1.5 87.50×72×1.5 110.00×72×1.5 121.25×72×1.5 132.50×72×1.5 143.75×72×1.5 155.00×72×1.5 166.25×72×1.5	22.50 33.75 45.00 56.25 67.50 78.75 90.00 101.25 112.50 123.75 135.00 146.25 157.50 168.75 180.00	222222222222222222222222222222222222222	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	1 1 1 2 2 2 2 3 3 3	1 1 2 2 2 2 2 2 2 2 2 2 3 3 3 3

Order example:

JMK module, length 90 mm (3.543), for printed circuit boards 87.5x72x1.5 (3.445x2.835x.059) comprising

19 70 00 2 2 side elements 19 70 01 5 1 base element 19 70 03 1 2 foot elements 19 70 03 1 2 foot elements

or printed circuit boards see catalog page 290.



The universal module UM is suitable to commodate one printed circuit board for ing in individual electronic circuits, e.g. ogrammable controls. They comprise indiual elements with various dimensions d functions. By arranging individual base ments in a row the printed circuit board face can be multiplied. Metal pins enae the individual base elements to form turdy unit. The various base elements are ailable with and without ribs to support printed circuit board. Do not locate der points or component fixings in the a of these ribs. Dependent upon the odule size one or more base elements fitted with a snap foot, which easily enge on DIN-EN mounting rails. The side eleents form both base element ends ariged in a row and are available in three ecutions.

the low side element UM-SE. the tall side element UM-SE-A 60 for 30 mm wide U profile covers and the tall side element UM-SE-A 73 for 73 mm wide U profile covers.

The tall side elements are available witht and with guide grooves for mechanical ng of the printed circuit board vertically the base PCB.

The transparent U profile covers are ailable in various lengths, which depend on the number of base elements used. ey are screw fitted for the tall side eleents. Furthermore an engageable transrent hood is available for a base element h snap foot for the lower side elements.

An adaptor rail is available for inserting European format cards. It is pushed latilly over the edge of the base elements is reducing the width to the European mat card dimension. Furthermore, varis modules are available for fitting Euroan format cards.

A comprehensive range of electronic nted circuit terminal blocks is available the conductor connection (see catalog ge 290).

wide U profile cove

Type of moldings

Polyamide 6.6, see catalog page 12 krilen

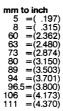
U profile cove

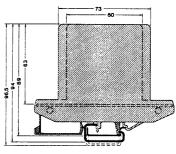
Unbreakable PVC max. temperature: 70° C

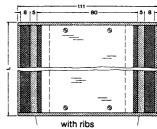
Transparent cover

Unbreakable polycarbonate, Difficult to ignite and self extinguishing, max hood temperature: 100° C

Marking and mounting material see catalog page 10

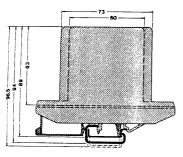


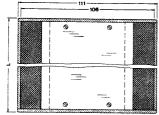




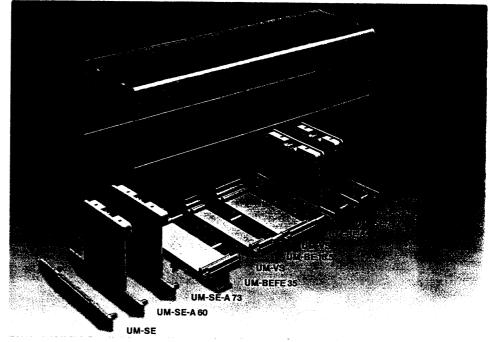
Description		Туре	Order No.	Pcs
Universal module, individual assembly, selectable consisting of: Base element with snap foot,				
for mounting on, a) with ribs, L=35 mm (1.378) b) without ribs, L=35 mm (1.378) Base element, without snap foot, necessary		a) UM-BEFE 35	29 55 56 4	10
for connection of several base elements a) with ribs, L=35 mm (1.378) b) without ribs, L=35 mm (1.378) Base element, without snap foot, necessary	<u></u>	a) UM-BE 35	29 55 57 7	10
for connection of several base elements a) with ribs, L=16.5 mm (.650) b) without ribs, L=16.5 mm (.650)	<u> </u>	a) UM-BE 16.5	29 56 90 3	10
Connection pin, brass, for joining several base elements into one unit, 4 pieces per element		UM-VS	29 55 58 0	50
Side element, low version, for connection on both ends of the base elements UM-BEFE. Side element, tall version,		UM-SE	29 55 59 3	10
for double sided connection of the base elements UM-BEFE for 60 mm wide U profile cover for 73 mm wide U profile cover Side element, as above, however, with guide grooves for vertically		UM-SE-A 60 UM-SE-A 73	29 55 61 6 29 55 60 3	10 10
arranged printed circuit boards for 60 mm wide U profile cover for 73 mm wide U profile cover		UM-SE-A 60-R UM-SE-A 73-R	29 56 89 3 29 56 74 1	10 10
U profile cover, transparent, a) 60 mm (2.362) wide, screw fitting on side element UM-SE-A 60				
for 1 base element 2 base elements 3 base elements 3 UM-BE35 UM-BE35		UM-A/U 60-35 UM-A/U 60-70 UM-A/U 60-105	29 55 65 8 29 55 66 1 29 55 67 4	1 1 1
4 base elements UM-BE35 and 1 base element UM-BE 16.5 for European format card 100x160x1.5 mm b) 73 mm (2.874) wide, screw fitting on		UM-A/U 60-156.5	29 55 55 1	1
side element UM-SE-A 73 for 1 base element UM-BE35 2 base elements UM-BE35 3 base elements UM-BE35		UM-A/U 73-35 UM-A/U 73-70 UM-A/U 73-105	29 55 62 9 29 55 63 2 29 55 64 5	1 1 1
4 base elements UM-BE35 and 1 base element UM-BE 16.5 for European format card 100 x 160 x 1.5 mm		UM-A/U 73-156.5	29 56 16 5	1
Transparent cover, transparent for one base element, UM-BEFE (with 2 UM-SE) engageable, 60 mm wide, 50 mm high		им-н	29 55 44 1	1
Adaptor, necessary for European format cards, pushed laterally over the edge of the base elements, reduces width to 100 mm, marking with labeling strip SKS, see catalog page 290, plastic, 156.5 mm (6.555) long		UM-AE	29 56 48 2	1
Universal module, complete accepting a European format card 100 x 160 mm, without U profile cover		UM-LG 160	29 56 94 5	1
Universal module , as above, however with an additional 60 mm (2.362) wide U profile cover		UM-LG 160/A 60	29 56 95 8	1
Universal module, as above, however with an additional 73 mm (2.874) wide U profile cover		UM-LG 160/A 73	29 56 97 4	1

U IVI without ribs





уре	•	Order No.	Pcs.



Assembly drawing of UM module base elements with ribs

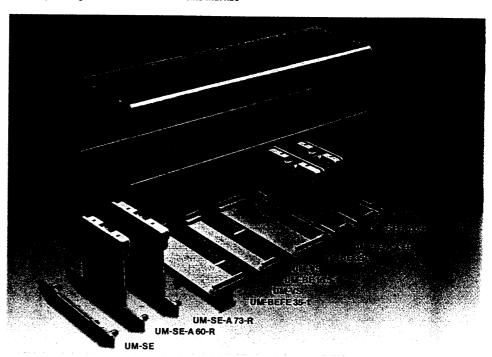
) UM-BEFE 35-1	29 56 66 0	10
) UM-BE 35-1	29 56 65 7	10
) UM-BE 16.5-1	29 58 05 3	- 10
M-VS	29 55 58 0	50
M-SE-1	29 58 14 7	10
M-SE-A 60 M-SE-A 73	29 55 61 6 29 55 60 3	10 10
M-SE-A 60-R M-SE-A 73-R	29 56 89 3 29 56 74 1	10 10
M-A/U 60-35 M-A/U 60-70 M-A/U 60-105	29 55 65 8 29 55 66 1 29 55 67 4	1 1 1

29 55 62 9 29 55 63 2 29 55 64 5

29 55 44 1

IM-A/U 73-35 IM-A/U 73-70 IM-A/U 73-105

ЈМ-Н



Assembly drawing of UM module base elements without ribs

Dimensions of the PCB* [mm]	Module length L [mm]	Base element UM-BEFE 35 UM-BEFE 35-1	Base element UM-BE 35 UM-BE 35-1	Base element UM-BE 16.5 UM-BE 16.5-1	Base element UM-SE UM-SE A 60 UM-SE-A 73	Length [mm] of th U profile cover UM-A/U 60 UM-A/U 73
38.5 x 107.5 x 1.5 55.0 x 107.5 x 1.5 73.5 x 107.5 x 1.5 90.0 x 107.5 x 1.5 108.5 x 107.5 x 1.5 125.0 x 107.5 x 1.5 143.5 x 107.5 x 1.5 160.0 x 107.5 x 1.5 178.5 x 107.5 x 1.5	40 56.5 75 91.5 110 126.5 145 161.5	1 1 2 2 2 2 2 2 2 2 3	- - 1 1 2 2	1 1 1 1	2 2 2 2 2 2 2 2 2 2 .	35 51.5 70 86.5 105 121.5 140 156.5 175

^{*}When using the adaptor UM-AE the printed circuit board is reduced to 100 mm (3.937).

UM-module, length 40 mm (1.575), for printed circuit board 38.5 x 107.5 x 1.5 (1.516 x 4.232 x .059) comprising 29 55 56 4 1 base element UM-BEFE 29 55 59 3 2 side elements UM-SE 29 55 44 1 1 cover UM

UM module 160 mm (6.299), for printed circuit boards in European format 100 x 160 x 1.5 (3.937 x 6.299 x .059) comprising 29 55 56 4 2 base elements with snap foot UM-BEFE 35 29 56 90 3 1 base element without snap foot UM-BE 16.5 29 55 58 0 12 connection pins UM-VS 29 55 61 6 2 side elements UM-SE A 60 29 55 55 1 1 U profile cover UM-A/U 60-156.5 1 adaptor UM-AE

UM module, length 110 mm (4.331), for printed circuit boa 108.5 x 107.5 x 1.5 (4.272 x 4.232 x .059) comprising 29.55.56.4 2 base elements with snap foot UM-BEFE 29.55.57 1 base element without snap foot UM-BE 8 connection pins UM-VS 29.55.60.3 2 side elements UM-SE-A.73 29.55.64.5 1 U profile cover UM-A/U 73-105

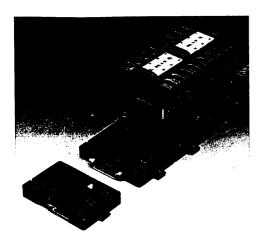
Information: For PCB terminals see catalog page 290.

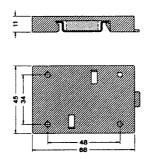
Mounting Plate EM-MP for Switching Equipment

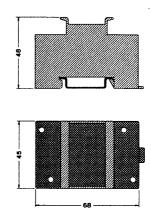
EM-MP

EM-MPG 45

45 mm wide







Description	Туре	Order No.	Pcs. Pkt.	Туре	Order No.	Pcs.
Mounting plate, for screw fitting size 0 switching equipment	EM-MP 45	29 44 15 1	5			
Mounting plate, enclosed design, to snap on size 0 switching equipment				EM-MPG 45	29 44 17 7	5
Cover, for the mounting plate EM-MP 45 for fitting protection elements	EM-MP 45 H	29 44 16 4	5			

These rail mounting plates have been specially conceived for size 0 switching equipment. They can accommodate Protection elements or coil protection circuits and motor interference suppression elements. Simple interface functions as linking element between electronic controls and conventional contactor controls can be realized in these units. The following two versions are available:

- Mounting plate EM-MP 45 for screwing onto size 0 switching equipment. The cover, which snaps below the mounting plate, accommodates protection elements for coil protection circuits. The connection lines of the protection elements for the coil connections can be led out of the mounting plate fronts.
- The enclosed mounting plate EM-MPG
 45 offering housing character permit size
 0 switching equipment to be snapped
 on. In the mounting plate interior interface functions and protection circuits for
 coil and motor interference suppression
 can be fitted. The connection lines between electronic circuit and switching
 equipment can be led out of the mounting plate front.

Both mounting plates snap on the symmetrical mounting rail in accordance with DIN 50 022.

mm to inch 11=(.433 34=(1.338 45=(1.772 48=(1.890 68=(2.677)